

International Forum on Microscopy

6-8 September 2019, Beijing, China

IFM 2019

Sponsors

Chinese Academy of Engineering (CAE)
China Instrument and Control Society (CIS)

Organizers

Microscopy Committee of China Instrument and Control Society (MCIS)
Harbin Institute of Technology (HIT)



The International Forum on Microscopy (IFM2019) is sponsored by Chinese Academy of Engineering (CAE) and China Instrument and Control Society (CIS), and organized by Microscopy Committee of China Instrument and Control Society (MCIS) and Harbin Institute of Technology (HIT). For the purpose of providing a platform for world masterminds in both science and engineering fields to exchange views on general development tendency, major issues, recent processes and appropriate industrial strategy. In addition, round-table talk discussion will be organized for world masterminds, specialists and entrepreneurs and common understanding reached will be basis for strategic planning for future development of microscopy.

Scopes

- Optical Microscopy
- Scanning Probe Microscopy
- Electron Microscopy
- Magnetic Force Microscope
- Acoustic Microscopy
- Radionuclide imaging
- Big Data Imaging and Artificial Intelligence
- Industrialization and Application

PhD Student Forum

PhD student forum on microscopy will be held as an individual section during the IFM2019



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International Forum on Microscopy

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(To be updated)

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Secretary-general

Prof. Weibo Wang, Harbin Institute of Technology (Harbin, China)

Prof. Haoyu Li, Harbin Institute of Technology (Harbin, China)

General requirements for papers

Please submit an introduction of the author (up to 1 page) and a structured extended abstract (up to 1 page) before the Abstract Due Date. The structured extended abstract should have figures, and sufficient data. Full manuscript is not needed.

All submissions will be peer reviewed by the full program committee for quality check.

Critical Dates

Abstract Due Date: **July 15, 2019**

Time and Venue

Check-in time: **September 6, 2019 (CST, UTC+8)**

Duration: **September 7-8, 2019 (CST, UTC+8)**

Venue: **Hotel to be determined, Beijing, China**

Further Information

Please use the following information to contact us:

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